

General Description

The CMSA150N04A uses advanced technology to provide excellent RDS (ON) . This device is suitable to be used as the low side FET in SMPS,load switching and general purpose.

Features

- $V_{DS} = 40V, I_D = 100A$
 $R_{DS(ON)} = 2.9m\Omega$ (typical) @ $V_{GS} = 10V$
 $R_{DS(ON)} = 4.8m\Omega$ (typical) @ $V_{GS} = 4.5V$
- Very low on-resistance $R_{DS(on)}$
- 100% avalanche tested
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current	100	A
$I_D @ T_C = 100^\circ C$		80	A
I_{DM}	Pulsed Drain Current	300	A
EAS	Single Pulse Avalanche Energy ¹	540	mJ
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	125	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	---	60	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction -Case	---	1.2	$^\circ C/W$

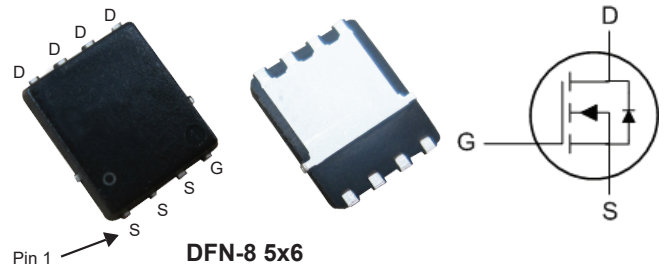
Product Summary

BVDSS	RDSON	ID
40V	2.9m Ω	100A

Applications

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

DFN-8 5x6 Pin Configuration



Type	Package	Marking
CMSA150N04A	DFN-8 5*6	CMSA150N04A

Electrical Characteristics ($T_j=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=20A$	---	---	2.9	$m\Omega$
		$V_{GS}=4.5V, I_D=20A$	---	---	4.8	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=32V, V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 16V, V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V, I_D=20A$	---	40	---	S
R_g	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	---	1.3	---	Ω
Q_g	Total Gate Charge	$V_{DD}=20V, I_D=20A$ $V_{GS}=10V$	---	43	---	nC
Q_{gs}	Gate-Source Charge		---	9	---	
Q_{gd}	Gate-Drain Charge		---	4	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=20V, V_{GS}=10V, R_G=3\Omega$ $R_L=1\Omega$	---	10	---	ns
T_r	Rise Time		---	4	---	
$T_{d(off)}$	Turn-Off Delay Time		---	33	---	
T_f	Fall Time		---	7	---	
C_{iss}	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1MHz$	---	4600	---	pF
C_{oss}	Output Capacitance		---	920	---	
C_{riss}	Reverse Transfer Capacitance		---	45.5	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Diode continuous forward current	$V_G=V_D=0V, \text{Force Current}$	---	---	100	A
$I_{S,pulse}$	Diode pulse current		---	---	300	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=20A, T_j=25^\circ\text{C}$	---	---	1.2	V

Notes

1. The test condition is $V_{DS}=20V, V_{GS}=10V, L=1mH, I_D=33A$.

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